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Docket No. 221015US90PCT



3742 \$

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: Atsushi ITO, et al.

SERIAL NO: 10/070,441

GAU: 3742

FILED: June 26, 2002

EXAMINER: FUQUA, S.

FOR: CERAMIC HEATER FOR A SEMICONDUCTOR PRODUCING/EXAMINING DEVICE

**INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97**

COMMISSIONER FOR PATENTS  
ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

**REFERENCES**

- ☐ The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

**RELATED CASES**

- ☒ Attached is a list of applicant's pending application(s) or issued patent(s) which may be related to the present application. A copy of the patent(s), together with a copy of the claims and drawings of the application(s) is attached along with PTO 1449.
- ☒ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

**CERTIFICATION**

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

**DEPOSIT ACCOUNT**

- ☒ Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

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Customer Number

**22850**

Tel. (703) 413-3000  
Fax. (703) 413-2220  
(OSMMN 05/03)

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Respectfully submitted,

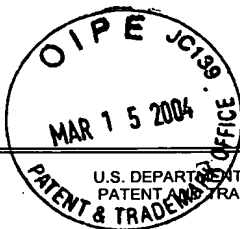
OBLON, SPIVAK, McCLELLAND,  
MAIER & NEUSTADT, P.C.

Masayasu Mori

Registration No. 47,301

**Joseph A. Scafetta, Jr.**

**Registration No. 26, 803**



Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY DOCKET NO. 221015US90PCT		SERIAL NO. 10/070,441	
LIST OF REFERENCES CITED BY APPLICANT				APPLICANT Atsushi ITO, et al.			
				FILING DATE June 26, 2002		GROUP 3742	
<b>U.S. PATENT DOCUMENTS</b>							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	2002/0043527	04/18/02	Yasutaka ITO			
	AB	2003/0015521	01/23/03	Yasutaka ITO			
	AC	6,507,006	01/14/03	Yasuji HIRAMATSU et al			
	AD	6,465,763	10/15/02	Yasutaka ITO et al			
	AE	6,677,557	06/13/04	Yasutaka ITO			
	AF	6,475,606	11/05/02	Takeo NIWA			
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						
<b>FOREIGN PATENT DOCUMENTS</b>							
		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION YES NO		
	AO						
	AP						
	AQ						
	AR						
	AS						
	AT						
	AU						
	AV						
<b>OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)</b>							
	AW						
	AX	<b>RECEIVED</b>					
	AY	<b>MAR 19 2004</b>					
	AZ	<b>TECHNOLOGY CENTER R3700</b>				<input type="checkbox"/> Additional References sheet(s) attached	
Examiner					Date Considered		
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							



# LIST OF RELATED CASES

<u>Docket Number</u>	<u>Serial or Patent Number</u>	<u>Filing or Issue Date</u>	<u>Inventor/ Applicant</u>
PER CLIENT	09/471,759	12/23/99	SAITO et al.
PER CLIENT	09/462,067	01/05/01	FURUKAWA et al.
PER CLIENT	10/345,356	01/16/03	ITO
PER CLIENT	09/787,954	03/23/01	ITO
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PER CLIENT	09/880,742	06/13/01	SAITO et al.
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\*Present Application; listed for information

# Abandoned Application

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\*Present Application; listed for information

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